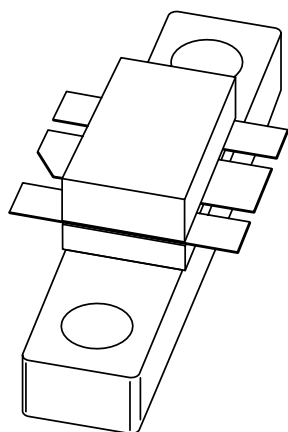


DATA SHEET



BLF544

UHF power MOS transistor

Product specification
Supersedes data of October 1992

1998 Jan 21

UHF power MOS transistor

BLF544

FEATURES

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

APPLICATIONS

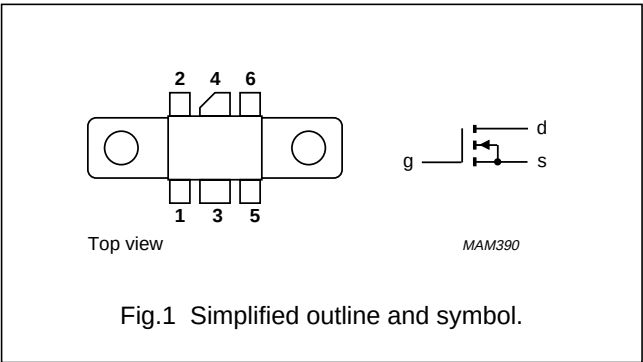
- Communication transmitters in the UHF frequency range.

DESCRIPTION

N-channel enhancement mode vertical D-MOS power transistor encapsulated in a 6-lead, SOT171A flange package with a ceramic cap. All leads are isolated from the flange.
A marking code showing gate-source voltage (V_{GS}) information is provided for matched pair applications.

PINNING - SOT171A

PIN	SYMBOL	DESCRIPTION
1	s	source
2	s	source
3	g	gate
4	d	drain
5	s	source
6	s	source



QUICK REFERENCE DATA

RF performance at $T_h = 25\text{ }^{\circ}\text{C}$ in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	η_D (%)
CW, class-B	500	28	20	>11	>50
CW, class-B	960	28	20	typ. 7	typ. 50

CAUTION
This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

WARNING
Product and environmental safety - toxic materials
This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

UHF power MOS transistor

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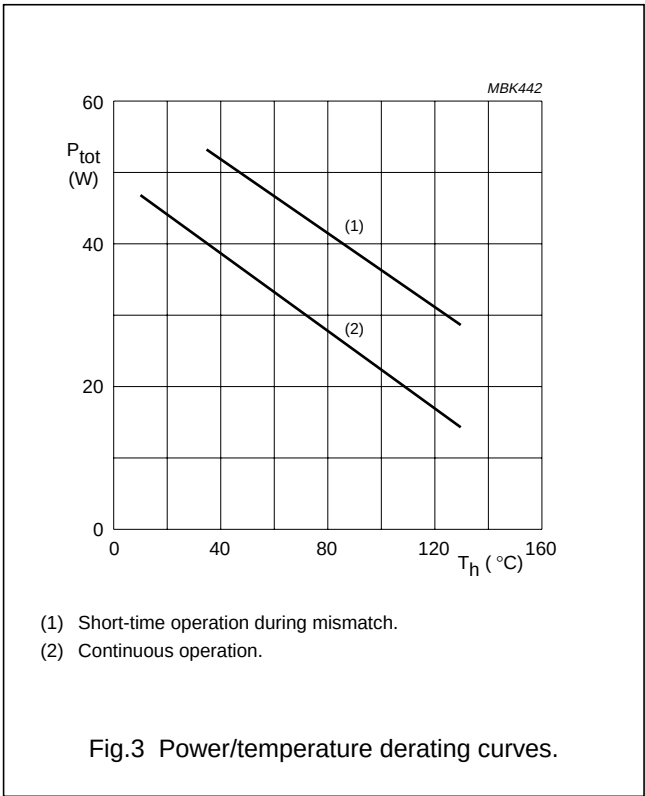
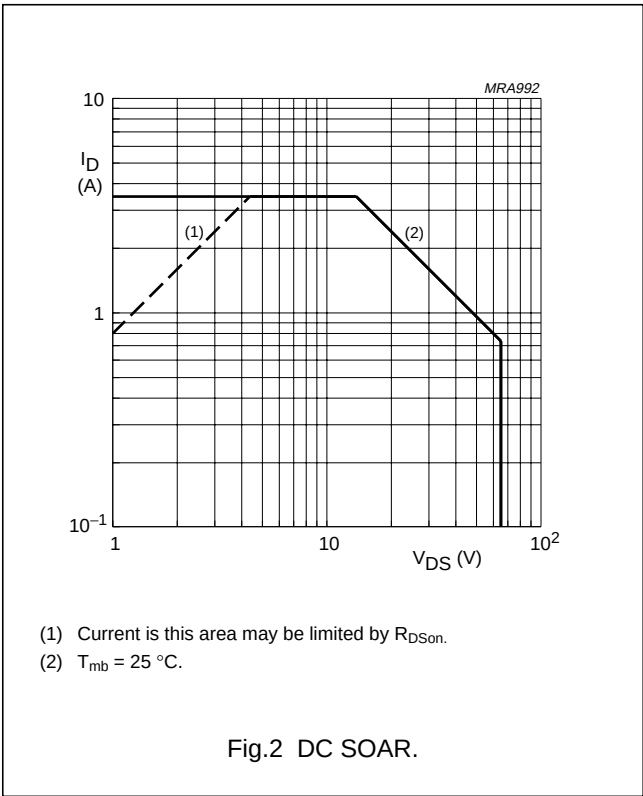
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage		–	65	V
V_{GS}	gate-source voltage		–	± 20	V
I_D	drain current (DC)		–	3.5	A
P_{tot}	total power dissipation	$T_{mb} \leq 25\text{ }^{\circ}\text{C}$	–	48	W
T_{stg}	storage temperature		–65	150	$^{\circ}\text{C}$
T_j	junction temperature		–	200	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	3.7	K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	0.4	K/W



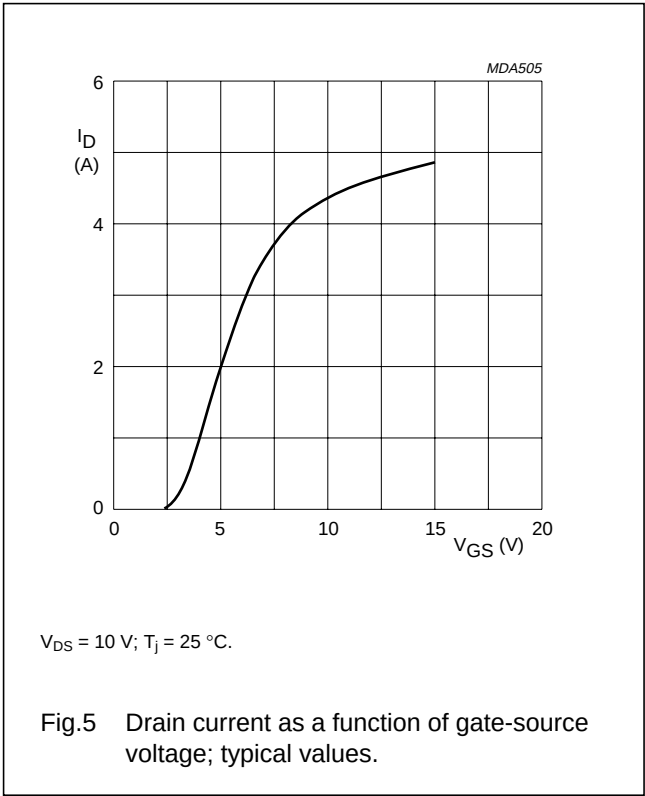
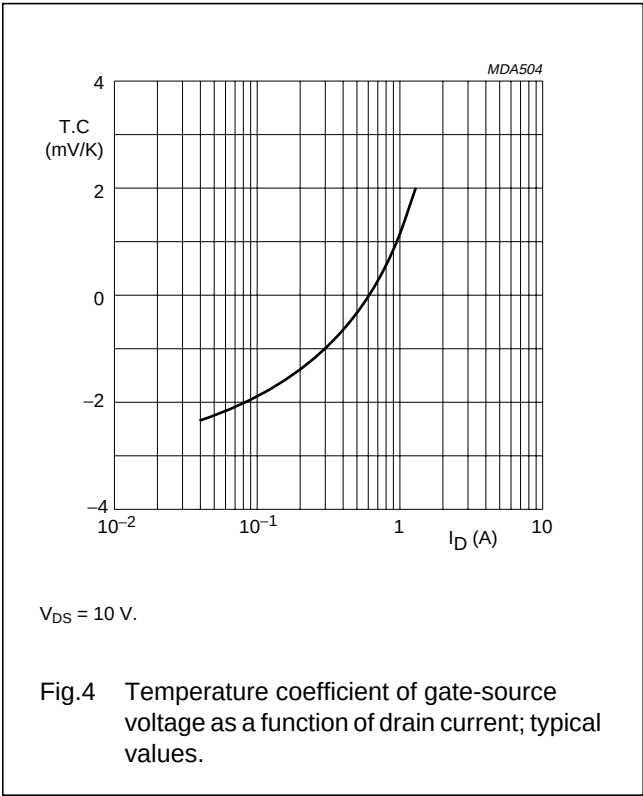
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CHARACTERISTICS

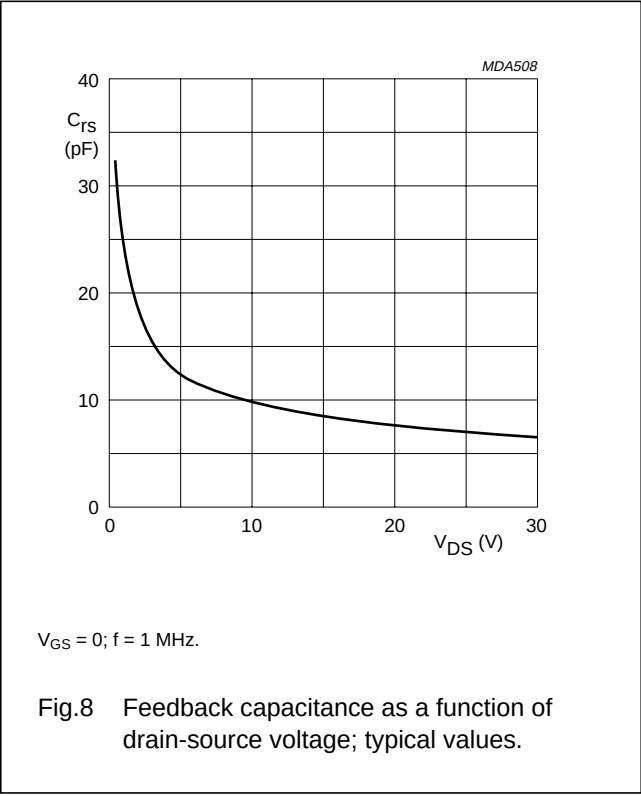
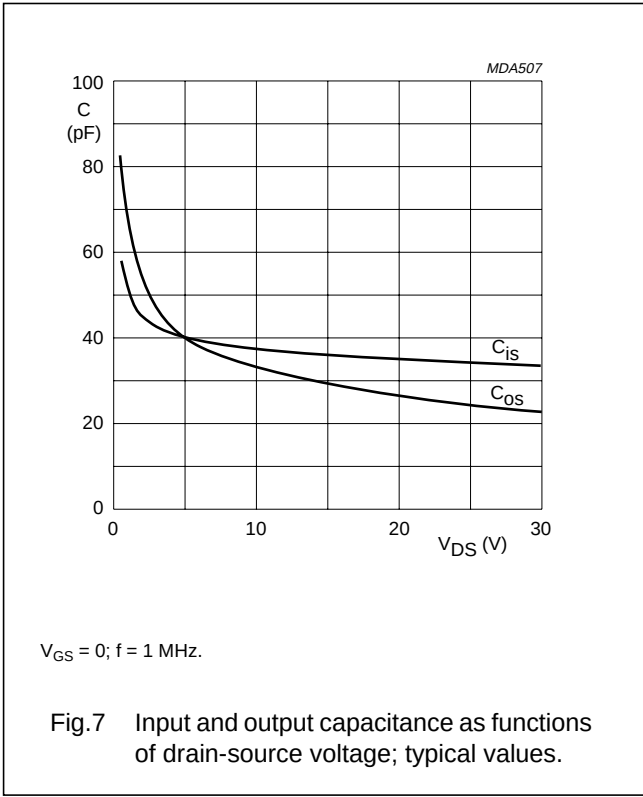
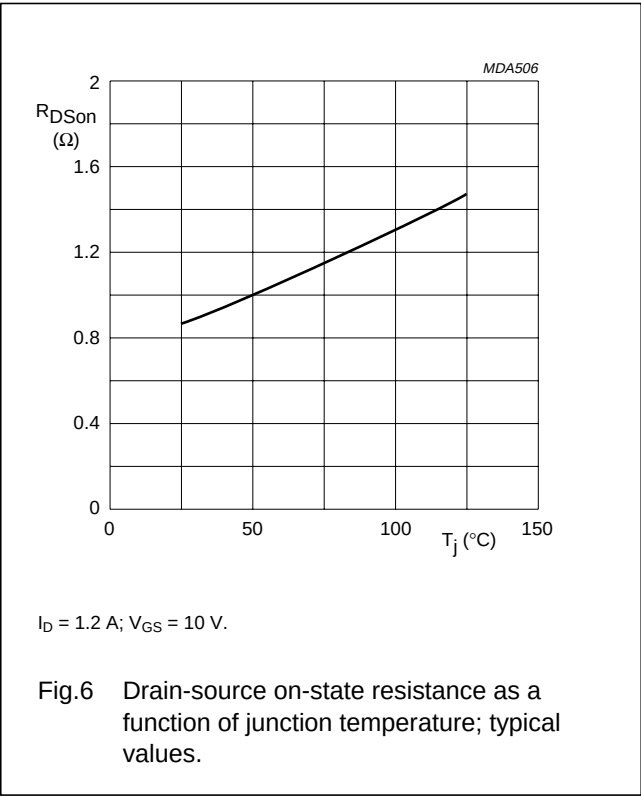
T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 10 mA	65	–	–	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	–	–	1	mA
I _{GSS}	gate-source leakage current	V _{GS} = ±20 V; V _{DS} = 0	–	–	1	µA
V _{GSth}	gate-source threshold voltage	I _D = 40 mA; V _{DS} = 10 V	1	–	4	V
ΔV _{GSth}	gate-source voltage difference of matched pairs	I _D = 40 mA; V _{DS} = 10 V	–	–	100	mV
g _{fs}	forward transconductance	I _D = 1.2 A; V _{DS} = 10 V	600	900	–	mS
R _{DSon}	drain-source on-state resistance	I _D = 1.2 A; V _{GS} = 10 V	–	0.85	1.25	Ω
I _{DSX}	on-state drain current	V _{GS} = 15 V; V _{DS} = 10 V	–	4.8	–	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	32	–	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	24	–	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	6.4	–	pF



UHF power MOS transistor

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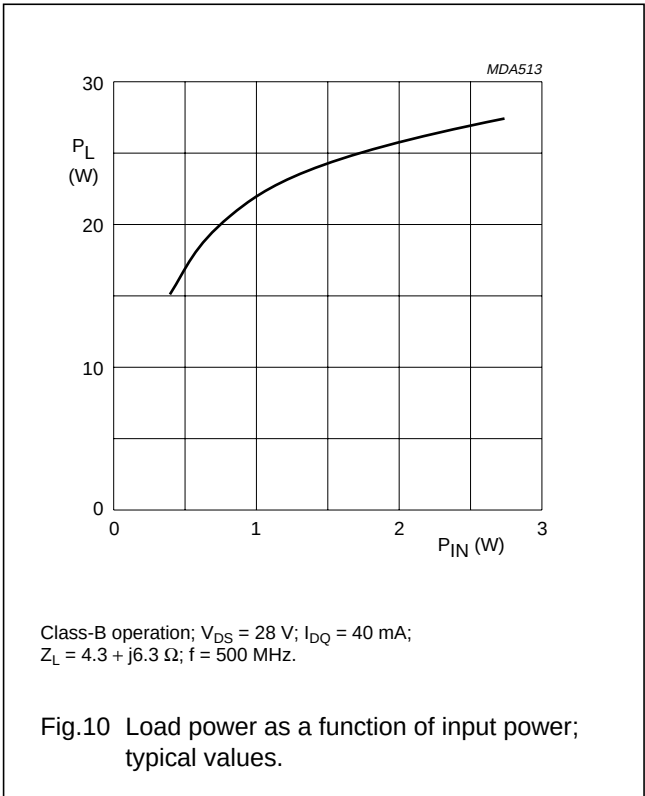
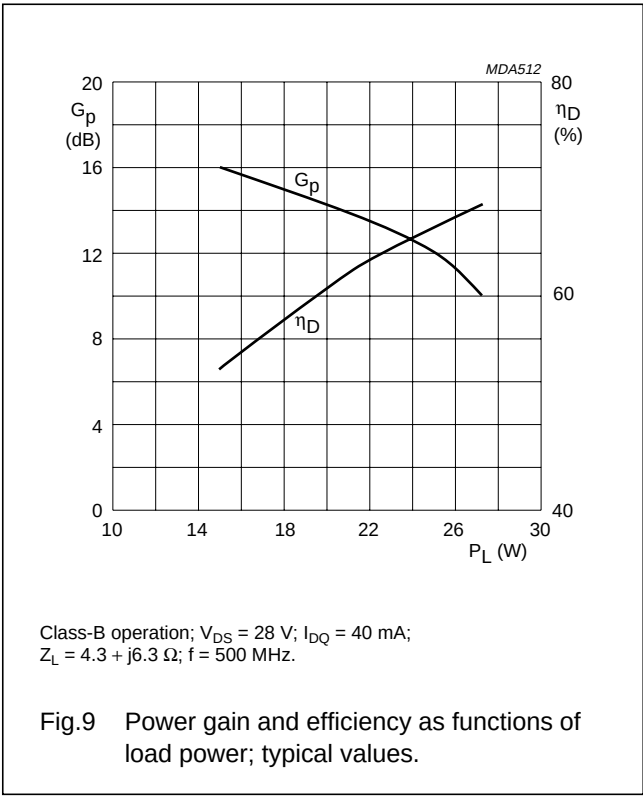
APPLICATION INFORMATION

$T_h = 25\text{ }^{\circ}\text{C}$; $R_{th\text{ mb-h}} = 0.4\text{ K/W}$ unless otherwise specified.
RF performance in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	40	20	>11 typ. 14	>50 typ. 60
CW, class-B	960	28	40	20	typ. 7	typ. 50
CW, class-B	960	24	40	15	typ. 7	typ. 50

Ruggedness in class-B operation

The BLF544 is capable of withstanding a full load mismatch corresponding to VSWR = 50 : 1 through all phases under the following conditions: $V_{DS} = 28\text{ V}$; $f = 500\text{ MHz}$ at rated output power.



UHF power MOS transistor

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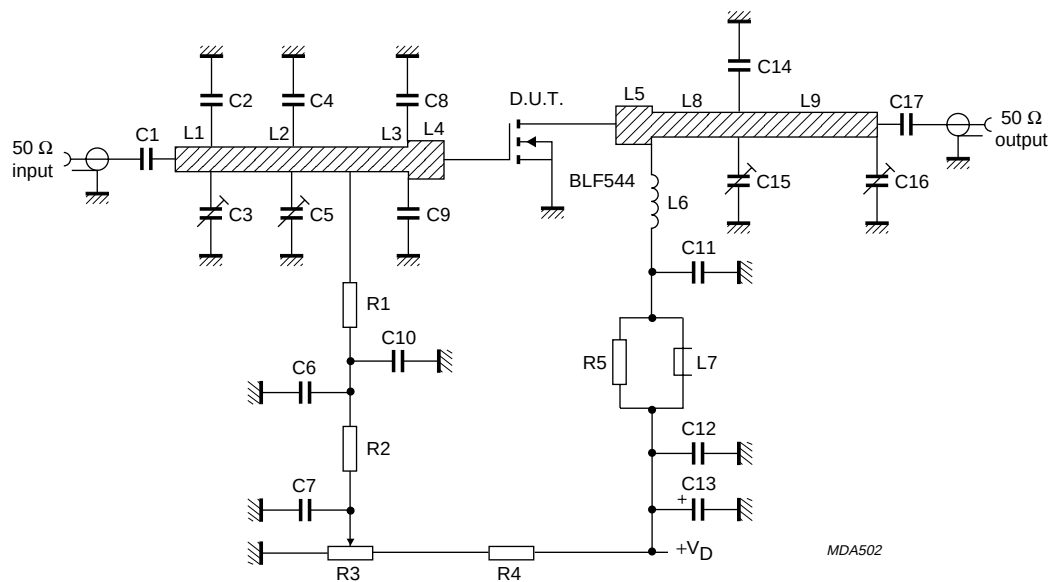
 $f = 500 \text{ MHz}$

Fig.11 Test circuit for class-B operation.

UHF power MOS transistor

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List of components (see Figs 11 and 12).

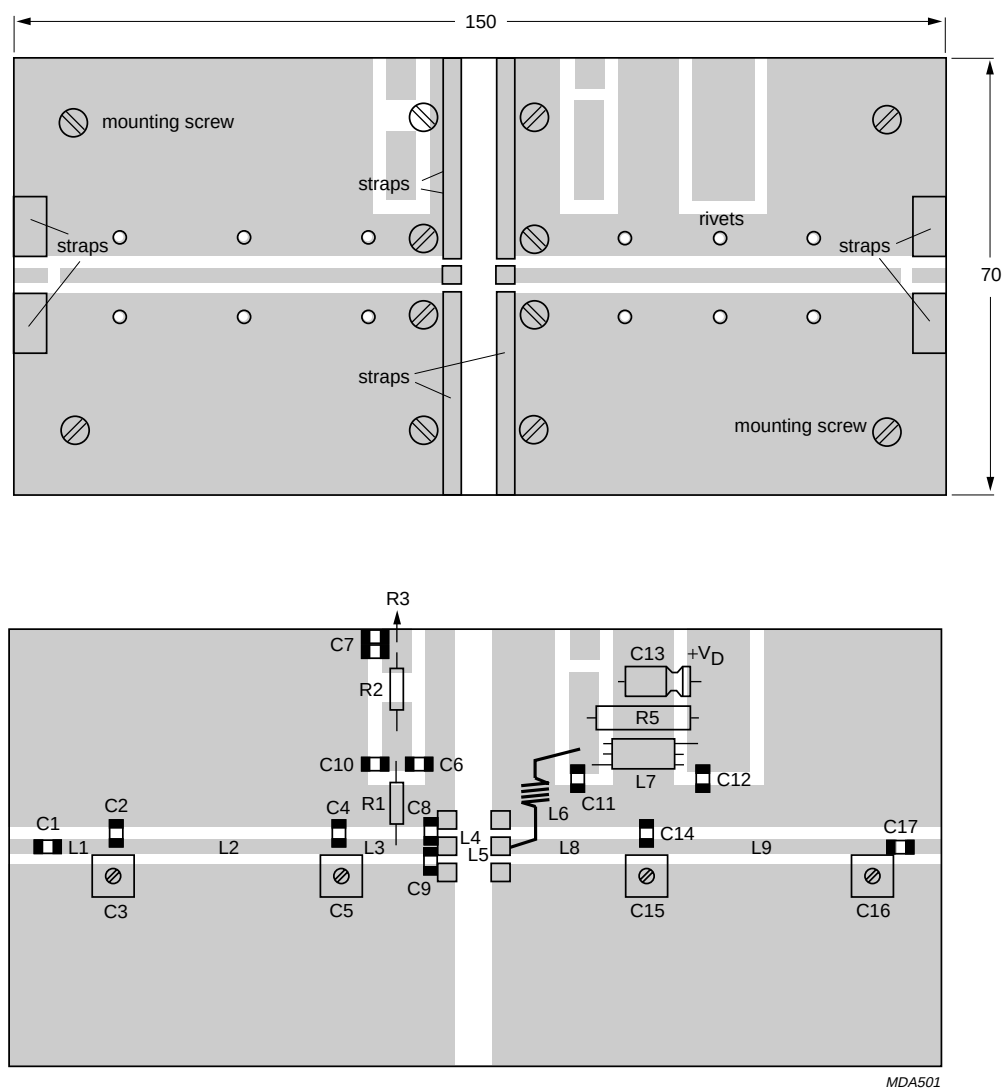
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C6, C11, C17	multilayer ceramic chip capacitor; note 1	390 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C3, C5	film dielectric trimmer	2 to 9 pF		2222 809 09002
C4	multilayer ceramic chip capacitor; note 2	27 pF; 50 V		
C7	multilayer ceramic chip capacitor	2 × 100 nF in parallel; 50 V		2222 852 47104
C8, C9	multilayer ceramic chip capacitor; note 2	39 pF		
C10, C12	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C13	electrolytic capacitor	4.7 µF; 63 V		2222 030 38478
C14	multilayer ceramic chip capacitor; note 1	20 pF; 500 V		
C15, C16	film dielectric trimmer	2 to 18 pF		2222 809 09003
L1	stripline note 3	50 Ω	9.5 × 2.5 mm	
L2	stripline note 3	50 Ω	34.5 × 2.5 mm	
L3	stripline note 3	50 Ω	17.5 × 2.5 mm	
L4, L5	stripline note 3	42 Ω	3 × 3 mm	
L6	4 turns enamelled 0.8 mm copper wire	31 nH	length 7.5 mm int. dia. 3 mm leads 2 × 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L8	stripline note 3	50 Ω	22 × 2.5 mm	
L9	stripline note 3	50 Ω	39.5 × 2.5 mm	
R1, R2	0.4 W metal film resistor	1 kΩ		2322 151 11002
R3	10 turns cermet potentiometer	50 kΩ		
R4	0.4 W metal film resistor	140 kΩ		2322 151 11404
R5	1 W metal film resistor	10 Ω		2322 153 51009

Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
3. The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

UHF power MOS transistor

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MDA501

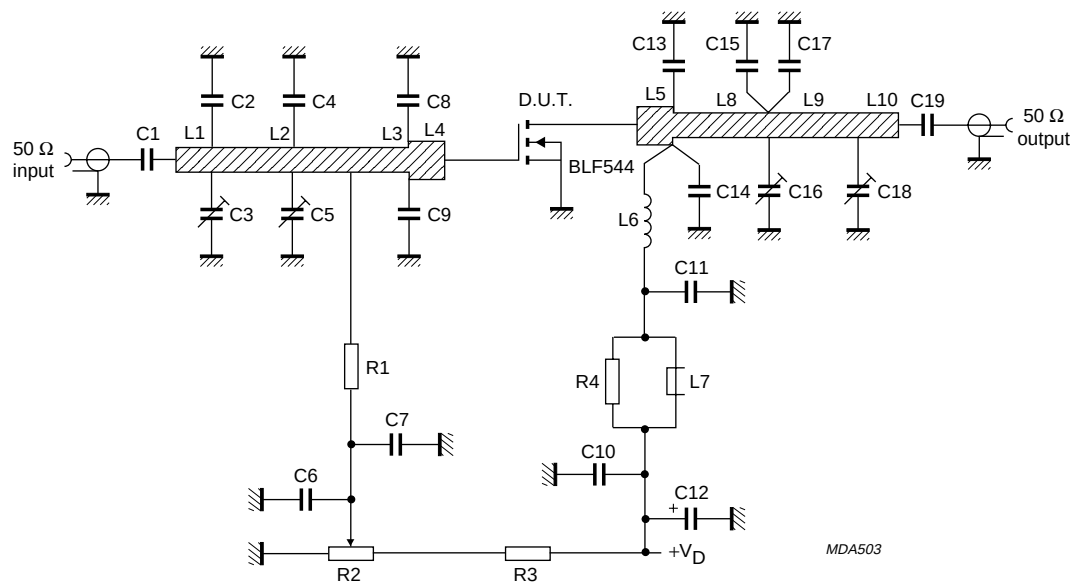
Dimensions in mm.

The circuit and components are situated on one side of the printed circuit board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 500 MHz class-B test circuit.

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$f = 960 \text{ MHz.}$

Fig.13 Test circuit for class-B operation.

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List of components (see Figs 12 and 13)

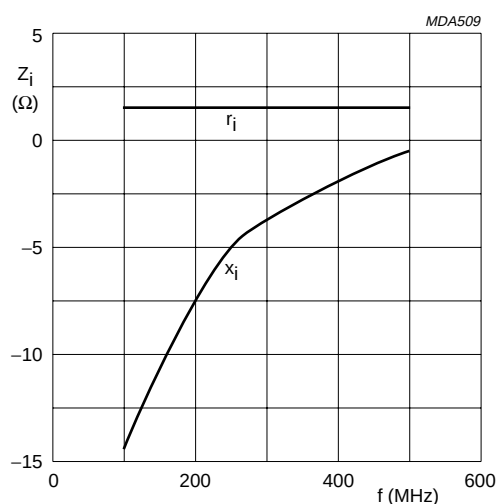
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1	multilayer ceramic chip capacitor; note 1	68 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	1.6 pF; 50 V		
C3, C5, C16, C18	film dielectric trimmer	1.4 to 5.5 pF		2222 809 09001
C4	multilayer ceramic chip capacitor; note 2	1 pF; 50 V		
C6	multilayer ceramic chip capacitor	10 nF; 50 V		2222 852 47103
C7, C11	multilayer ceramic chip capacitor; note 1	56 μ F; 500 V		
C8, C9, C15, C17	multilayer ceramic chip capacitor note 2	6.8 μ F; 50 V		
C10	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C12	electrolytic capacitor	4.7 μ F; 63 V		2222 030 38478
C13	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C14	multilayer ceramic chip capacitor; note 2	18 pF; 50 V		
C19	multilayer ceramic chip capacitor; note 1	62 pF; 500 V		
L1, L8	stripline; note 3	50 Ω	6 $\times$ 2.5 mm	
L2	stripline; note 3	50 Ω	38 $\times$ 2.5 mm	
L3	stripline; note 3	50 Ω	17.5 $\times$ 2.5 mm	
L4, L5	stripline; note 3	42 Ω	3 $\times$ 3 mm	
L6	2 turns enamelled 1 mm copper wire	16 nH	length 3.4 mm int. dia. 3 mm leads 2 $\times$ 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L9	stripline; note 3	50 Ω	21 $\times$ 2.5 mm	
L10	stripline; note 3	50 Ω	34.5 $\times$ 2.5 mm	
R1	0.4 W metal film resistor	15 k Ω		2322 151 11473
R2	10 turns potentiometer	50 k Ω		
R3	0.4 W metal film resistor	140 k Ω		2322 151 11404
R4	0.4 W metal film resistor	10 Ω		2322 153 51009

Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
3. The striplines are on a double copper-clad printed-circuit board with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

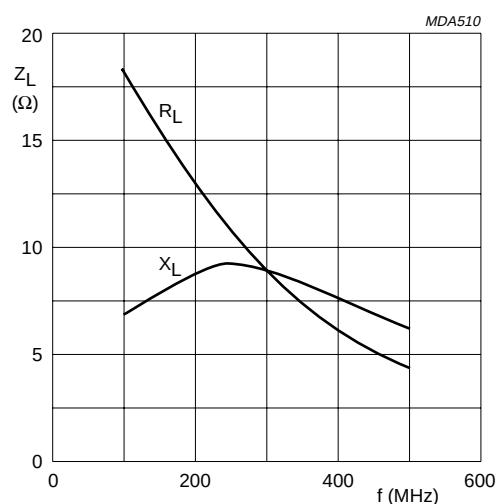
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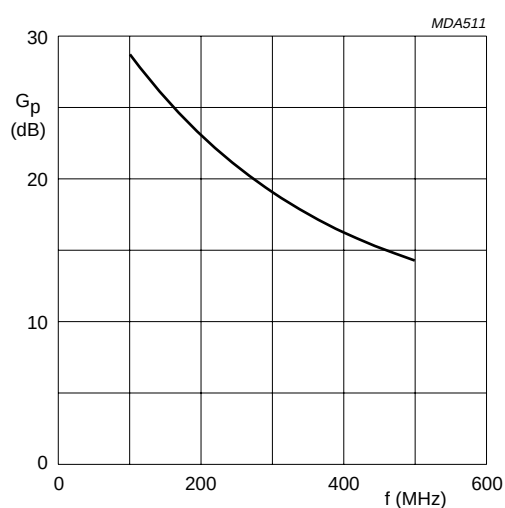
Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.14 Input impedance as a function of frequency (series components); typical values.



Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.15 Load impedance as a function of frequency (series components); typical values.



Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.16 Power gain as a function of frequency; typical values.

Optimum input and load impedances

Optimum input impedance: $1.2 + j4.8 \Omega$.

Optimum load impedance: $2.6 - j3.1 \Omega$.

Conditions: class-B operation; $V_{DS} = 24$ V;
 $I_{DQ} = 40$ mA; $f = 960$ MHz; $P_L = 15$ W; typical values.

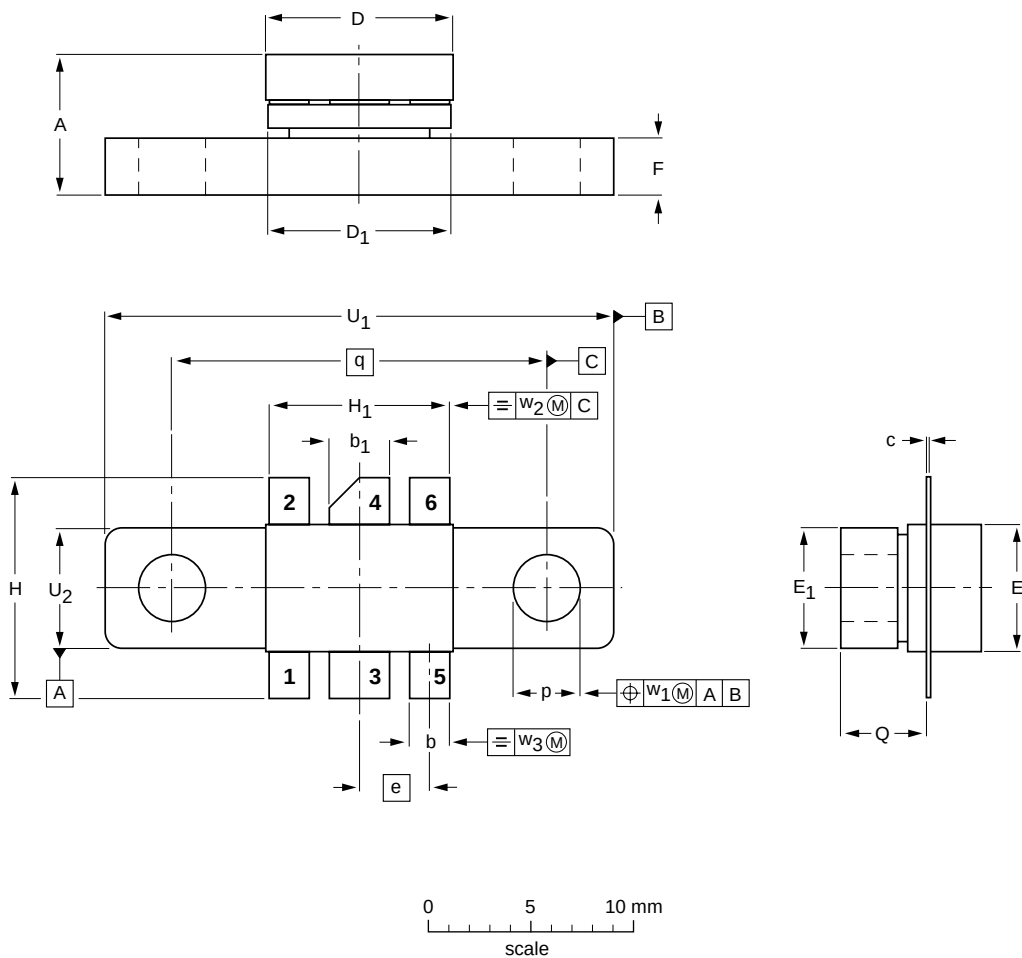
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 6 leads

SOT171A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	b ₁	c	D	D ₁	E	E ₁	e	F	H	H ₁	p	Q	q	U ₁	U ₂	w ₁	w ₂	w ₃
mm	6.81 6.07	2.15 1.85	3.20 2.89	0.16 0.07	9.25 9.04	9.30 8.99	5.95 5.74	6.00 5.70	3.58	3.05 2.54	11.31 10.54	9.27 9.01	3.43 3.17	4.32 4.11	18.42	24.90 24.63	6.00 5.70	0.51	1.02	0.26
inches	0.268 0.239	0.085 0.073	0.126 0.114	0.006 0.003	0.364 0.356	0.366 0.354	0.234 0.226	0.236 0.224	0.140	0.120 0.100	0.445 0.415	0.365 0.355	0.135 0.125	0.170 0.162	0.725	0.980 0.970	0.236 0.224	0.02	0.04	0.01

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT171A						97-06-28

UHF power MOS transistor

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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